

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit : 1712
Examiner : Patricia A. Short
Serial No. : 10/089,842
Filed : April 4, 2002
Inventors : Hideo Matsuoka
: Mitsushige Hamaguchi
: Kazuhiko Kobayashi
: Akira Todo
: Taku Koda
Title : RESIN STRUCTURE
: AND USE THEREOF



035811

PATENT & TRADEMARK OFFICE

Docket No.: 1099-02

Confirmation No.: 5262

Dated: May 29, 2003

RECEIVED
JUN 06 2003
TC 1700

Handwritten signature and initials, including "B1" and "H10".

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Official Action dated April 4, 2003, Applicants amend the Application as follows:

In the Claims

1. (Previously cancelled)
2. (Previously amended) A thermoplastic resin structure formed of a resin composition that comprises substantially (a) from 55 to 80 % by volume of a polyolefin resin and (b) from 20 to 45 % by volume of a polyphenylene sulfide resin, which is characterized in that, in morphology therein seen through electronic microscopy, the polyphenylene sulfide resin (b) forms a matrix phase (continuous phase) and the polyolefin resin (a) forms a disperse phase.
3. (Previously amended) The thermoplastic resin structure as claimed in claim 2, for which the blend ratio of the polyolefin resin (a) and the polyphenylene sulfide resin (b) is such that the former accounts for from 60 to 75 % by volume and the latter for from 25 to 40 % by volume.